

ISL9K30120G3

30A, 1200V Stealth™ Dual Diode

General Description

The ISL9K30120G3 is a Stealth™ dual diode optimized for low loss performance in high frequency hard switched applications. The Stealth™ family exhibits low reverse recovery current ($I_{RM(REC)}$) and exceptionally soft recovery under typical operating conditions.

This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low $I_{RM(REC)}$ and short t_a phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the Stealth™ diode with a 1200V NPT IGBT to provide the most efficient and highest power density design at lower cost.

Formerly developmental type TA49415.

Features

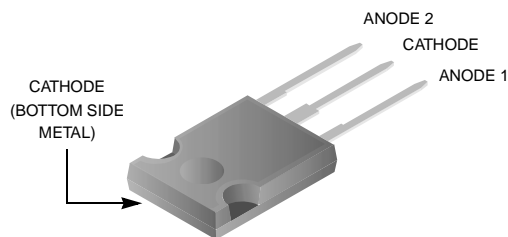
- Soft Recovery $t_b / t_a > 4.5$
- Fast Recovery $t_{rr} < 56ns$
- Operating Temperature 150°C
- Reverse Voltage 1200V
- Avalanche Energy Rated

Applications

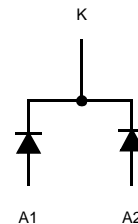
- Switch Mode Power Supplies
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode

Package

JEDEC STYLE TO-247



Symbol



Device Maximum Ratings (per leg) $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{RRM}	Repetitive Peak Reverse Voltage	1200	V
V_{RWM}	Working Peak Reverse Voltage	1200	V
V_R	DC Blocking Voltage	1200	V
$I_{F(AV)}$	Average Rectified Forward Current ($T_C = 80^\circ\text{C}$)	30	A
	Total Device Current (Both Legs)	60	A
I_{FRM}	Repetitive Peak Surge Current (20kHz Square Wave)	70	A
I_{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60Hz)	325	A
P_D	Power Dissipation	166	W
E_{AVL}	Avalanche Energy (1A, 40mH)	20	mJ
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	°C
T_L	Maximum Temperature for Soldering		
T_{PKG}	Leads at 0.063in (1.6mm) from Case for 10s	300	°C
	Package Body for 10s, See Application Note AN-7528	260	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Package Marking and Ordering Information

Device Marking	Device	Package	Tape Width	Quantity
K30120G3	ISL9K30120G3	TO-247	N/A	30

Electrical Characteristics (per leg) TC = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off State Characteristics

I _R	Instantaneous Reverse Current	V _R = 1200V	T _C = 25°C	-	-	100	μA
			T _C = 125°C	-	-	1.0	mA

On State Characteristics

V _F	Instantaneous Forward Voltage	I _F = 30A	T _C = 25°C	-	2.8	3.3	V
			T _C = 125°C	-	2.6	3.1	V

Dynamic Characteristics

C _J	Junction Capacitance	V _R = 10V, I _F = 0A	-	115	-	pF
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Switching Characteristics

t _{rr}	Reverse Recovery Time	I _F = 1A, di _F /dt = 100A/μs, V _R = 15V	-	45	56	ns
		I _F = 30A, di _F /dt = 100A/μs, V _R = 15V	-	80	100	ns
t _{rr}	Reverse Recovery Time	I _F = 30A, di _F /dt = 200A/μs, V _R = 780V, T _C = 25°C	-	269	-	ns
I _{RM(REC)}	Maximum Reverse Recovery Current		-	7.5	-	A
Q _{RR}	Reverse Recovered Charge		-	930	-	nC
t _{rr}	Reverse Recovery Time		-	529	-	ns
S	Softness Factor (t _b /t _a)	I _F = 30A, di _F /dt = 200A/μs, V _R = 780V, T _C = 125°C	-	6.2	-	-
I _{RM(REC)}	Maximum Reverse Recovery Current		-	11	-	A
Q _{RR}	Reverse Recovered Charge		-	3.0	-	μC
t _{rr}	Reverse Recovery Time		-	260	-	ns
S	Softness Factor (t _b /t _a)	I _F = 30A, di _F /dt = 1000A/μs, V _R = 780V, T _C = 125°C	-	4.8	-	-
I _{RM(REC)}	Maximum Reverse Recovery Current		-	30	-	A
Q _{RR}	Reverse Recovered Charge		-	3.4	-	μC
di _M /dt	Maximum di/dt during t _b		-	520	-	A/μs

Thermal Characteristics

R _{θJC}	Thermal Resistance Junction to Case	TO-247	-	-	0.75	°C/W
R _{θJA}	Thermal Resistance Junction to Ambient	TO-247	-	-	30	°C/W

Typical Performance Curves (per leg)

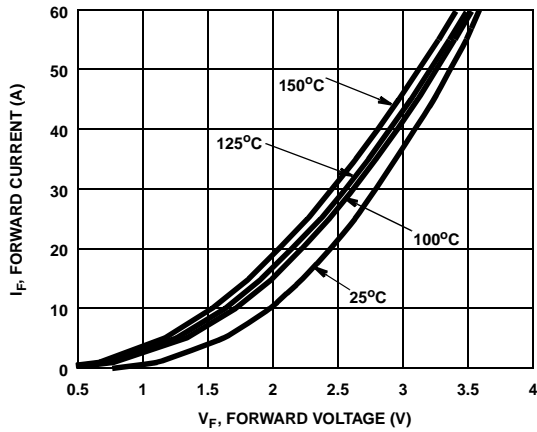


Figure 1. Forward Current vs Forward Voltage

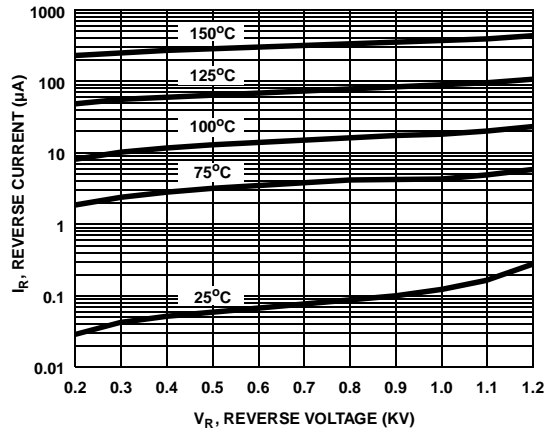


Figure 2. Reverse Current vs Reverse Voltage

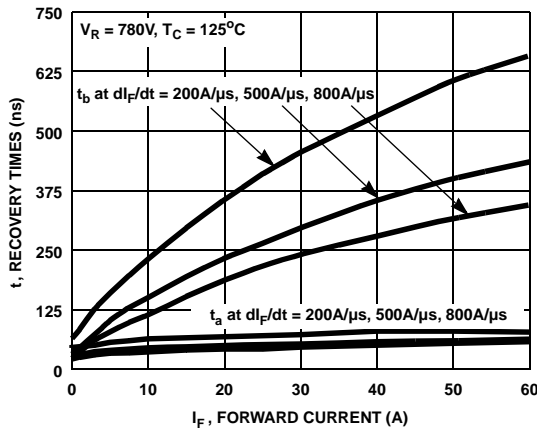


Figure 3. t_a and t_b Curves vs Forward Current

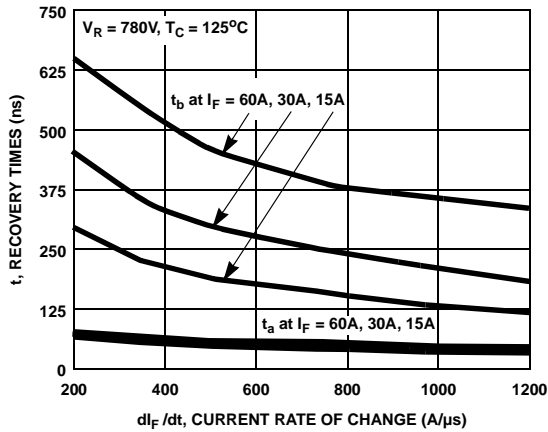


Figure 4. t_a and t_b Curves vs di_F/dt

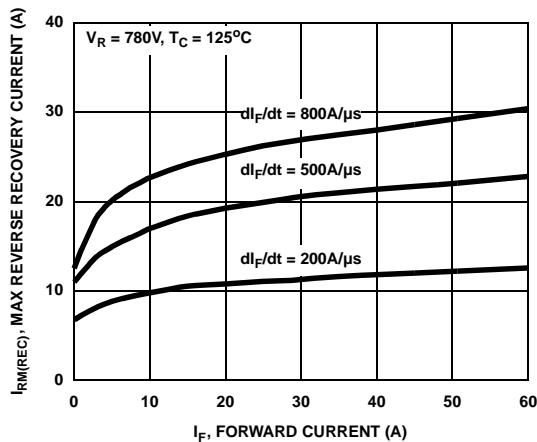


Figure 5. Maximum Reverse Recovery Current vs Forward Current

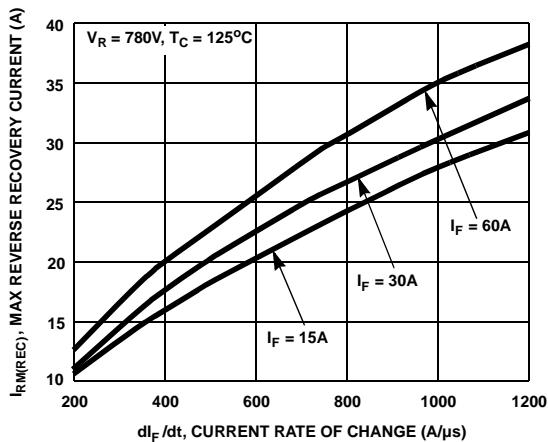


Figure 6. Maximum Reverse Recovery Current vs di_F/dt

Typical Performance Curves (per leg) (Continued)

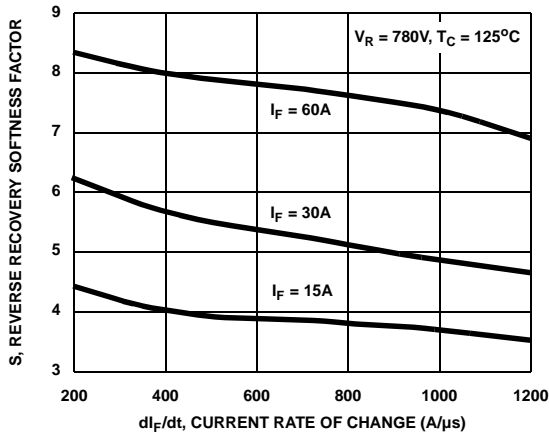


Figure 7. Reverse Recovery Softness Factor vs di_F/dt

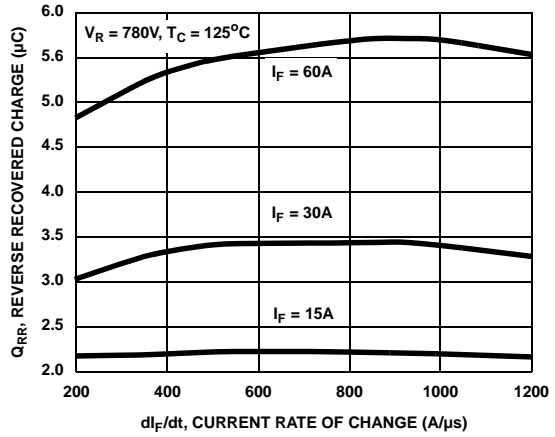


Figure 8. Reverse Recovery Charge vs di_F/dt

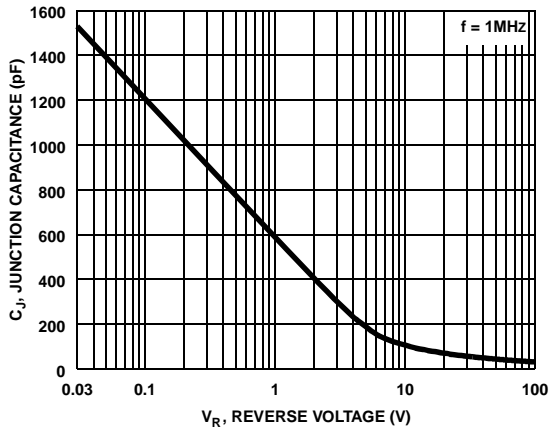


Figure 9. Junction Capacitance vs Reverse Voltage

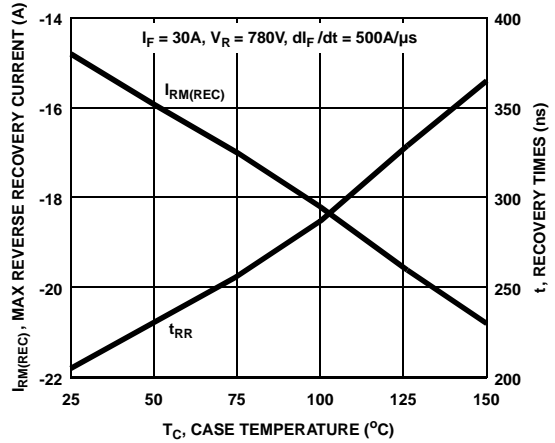


Figure 10. Maximum Reverse Recovery Current and t_{rr} vs Case Temperature

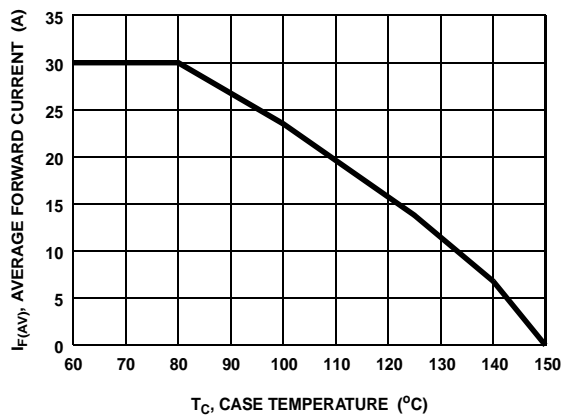


Figure 11. DC CURRENT DERATING CURVE

Typical Performance Curves (per leg) (Continued)

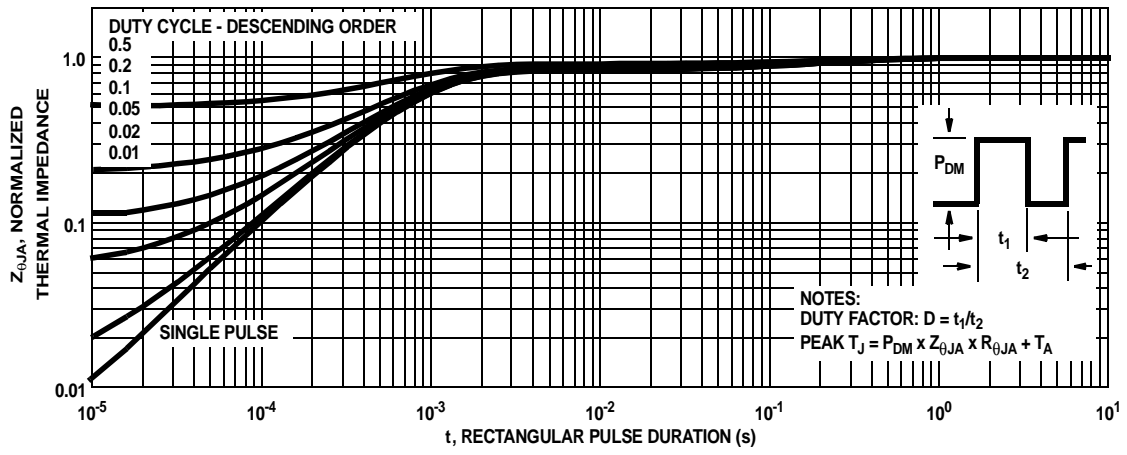


Figure 12. Normalized Maximum Transient Thermal Impedance

Test Circuit and Waveforms

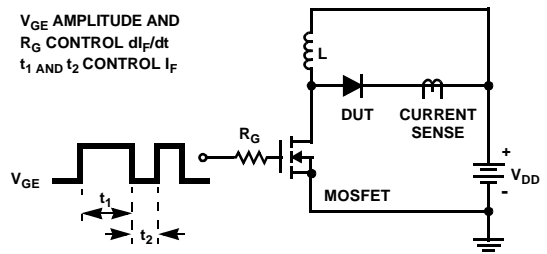


Figure 13. t_{rr} Test Circuit

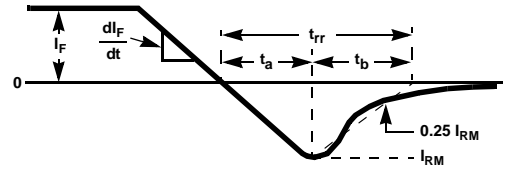


Figure 14. t_{rr} Waveforms and Definitions

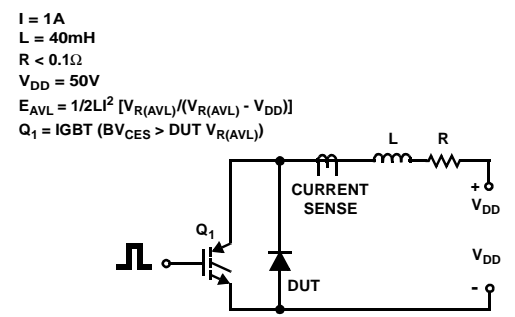


Figure 15. Avalanche Energy Test Circuit

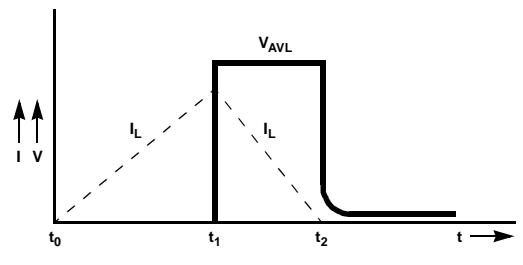


Figure 16. Avalanche Current and Voltage Waveforms

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DOME [™]	HiSeC [™]	Power247 [™]	SuperSOT [™] -3	
EcoSPARK [™]	I ² C [™]	PowerTrench [®]	SuperSOT [™] -6	
E ² CMOS [™]	ISOPLANAR [™]	QFET [™]	SuperSOT [™] -8	
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